

# APPROVAL SHEET

## **MR02X(W)**

±5%, ±1%

Thick Film General purpose chip resistors Automotive compliant AEC Q-200 qualified Size 0201

\*Contents in this sheet are subject to change without prior notice.



#### **FEATURE**

- 1. Automotive grade AEC Q200 qualified with 100% CCD visual inspection
- 2. High reliability and stability 1%
- 3. Reduced size of final equipment
- 4. Suitable for high density print circuit board assembly
- 5. Higher component and equipment reliability
- 6. Lead free product

#### **APPLICATION**

- · Mobile phone
- PDA
- Camcorders
- Palmtop computers
- Hybrid module

#### **DESCRIPTION**

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a pure Tin.

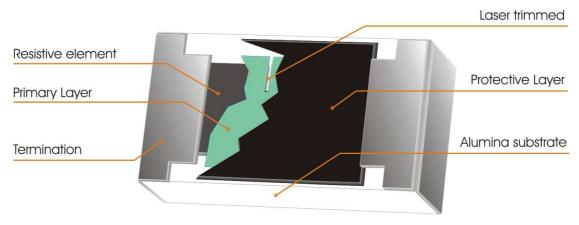


Fig 1. Construction of Chip-R MR02X



#### **QUICK REFERENCE DATA**

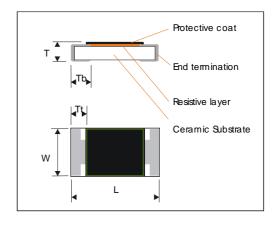
Item	General Specification		
Series No.	MR02X(W)_J		
Size code	0201(0603)		
Resistance Range	1Ω~10MΩ ( $\pm 5\%$ tolerance ), Jumper		
	1Ω~ 10ΜΩ	2 ( ±1% tolerance )	
Resistance Tolerance	±1% ±5%		
	E96+E24	E24	
TCR (ppm/°C)	1.02MΩ - 10MΩ, ≤±200ppm		
	51Ω - 1MΩ, ≤±100ppm		
	10Ω - 49.9Ω, ≤±200ppm		
	1 - 9.76Ω, +600 ~ -200ppm		
Max. dissipation @ T <sub>amb</sub> =70°C	1/20 W		
Max. Operation Voltage	25V		
Max. Overload Voltage	50V		
Operation temperature	-55 ~ +125°C		

#### Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by  $RCWV = \sqrt{RatedPower \times Resistance \, Value} \ or \ Max. \ RCWV \ listed \ above, \ whichever \ is \ lower.$
- 3. Jumper max. 50mohm, rated current 1A, peak current 2.5A

#### **DIMENSION(unit: mm)**

	MR02X(W)	
L	$0.60 \pm 0.03$	
W	<b>W</b> $0.30 \pm 0.03$	
Т	<b>T</b> $0.23 \pm 0.03$	
<b>Tb</b> 0.15 ± 0.05		
Tt	$0.10 \pm 0.05$	



#### **MARKING**

MR02X(W) has no marking.



#### **FUNCTIONAL DESCRIPTION**

#### **Product characterization**

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of  $\pm 5\%$  &  $\pm 1\%$ . The values of the E24/E96 series are in accordance with "IEC publication 60063"

#### Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

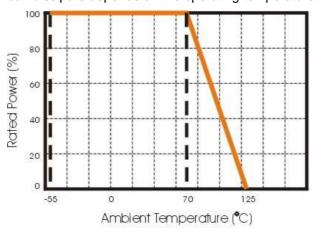


Figure 2. Maximum dissipation in percentage of rated power

As a function of the ambient temperature

#### **MOUNTING**

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

#### **SOLDERING CONDITION**

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

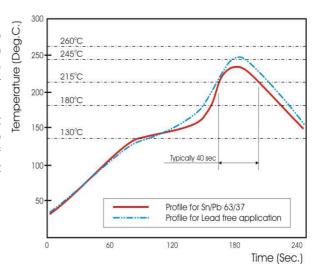


Fig 3. Infrared soldering profile for Chip Resistors MR02X(W)



#### **CATALOGUE NUMBERS**

The resistors have a catalogue number starting with:

MR02	Х	472_	J	Α	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
MR02:0201	X : Normal W : 1% For <10Ω / >1ΜΩ	5%, E24: 2 significant digits followed by no. of zeros $100\Omega = 101\_$ $10KΩ = 103$ $1%, E24+E96: 3$ significant digits followed by no. of zeros $100\Omega = 1000$ $37.4KΩ = 3742$	J:±5% F:±1% P:Jumper	A : 7" Reeled (15Kpcs/Reel) G : 13" Reeled (70Kpcs/Reel)	L = Sn base (lead free)

Standard taping quantity 15,000pcs per 7" reel! 70,000pcs per 13" reel!



### TEST AND REQUIREMENTS (JIS C 5201-1 : 1998)

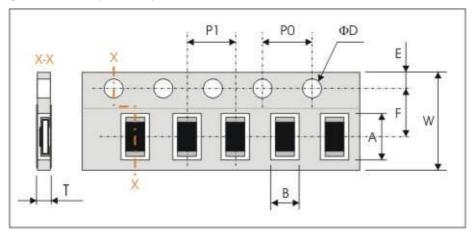
TEGT	PROCEDURE / TEST METUOR	REQUIREMENT		
TEST	PROCEDURE / TEST METHOD	Resistor	0Ω	
Electrical Characteristics	- DC resistance values measurement	Within the specified tolerance		
	- Temperature Coefficient of Resistance (T.C.R)	Refer to "QUICK		
JISC5201-1: 1998 Clause 4.8	Natural resistance change per change in degree centigrade.	REFERENCE DATA"		
	$\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}  t_1 : 20\text{°C} + 5\text{°C} - 1\text{°C}$		<50mΩ	
	$R_1$ : Resistance at reference temperature (20°C+5°C/-1°C)			
	R₂: Resistance at test temperature (-55°C or +125°C)			
Short time overload (S.T.O.L)  Clause 4.13	.T.O.L) application of a voltage 2.5 times RCWV or the maximum		<50mΩ	
Resistance to soldering heat(R.S.H)	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C±5°C	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ ) no visible damage	<50mΩ	
AEC Q200-15	He was a decision of the control of	OFP/ coverage min good tinni		
Solderability Clause 4.17	Un-mounted chips completely immersed for 2±0.8second in a SAC solder bath at 235°C±5°C	95% coverage min., good tinnii visible damage	ng and no	
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃,			
AEC Q200-4	30 minutes at +125°C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 1000 continuous cycles	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )	< 50mΩ	
Bias Humidity	1000 +48/-0 hours, loaded with RCWV or Vmax in	$\Delta$ R/R max. $\pm$ (1%+0.10 $\Omega$ )		
AEC Q200-7	humidity chamber controller at +85°C/85%RH, 10% rated		$<$ 50m $\Omega$	
	power applied continuously,			
Operational Life 1000+48/-0 hours; 35% of operation power, 125±2°C MIL-STD-202 method 108		$\Delta$ R/R max. $\pm$ (1%+0.10 $\Omega$ )	< 50mΩ	
High Temperature	1000 hrs @ 125°C, un-powered	$\Delta$ R/R max. $\pm$ (1%+0.10 $\Omega$ )		
Exposure			$<$ 50m $\Omega$	
AEC Q200-3				
Bending strength	Resistors mounted on a 90mm glass epoxy resin	No visual damaged,	< 50mΩ	
AEC Q200 -21	PCB(FR4), bending once 2mm for 60sec.	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )	< 5011122	
Adhesion	Pressurizing force: 3N, Test time: 10±1sec.	No remarkable damage or remo	oval of the	
AEC Q200-22		terminations		
Vibration	5 g's for 20 min , 12 cycles each of 3 orientations	$\triangle$ R/R max $\leq$ ±(0.5%+0.05 $\Omega$ )	< 50mΩ	
AEC Q200-14		and no visible damage		
Mechanical Shock	Shock machine, half sine,	$\triangle$ R/R max $\leq$ ±(0.5%+0.05 $\Omega$ )	< 50mΩ	
AEC Q200-13	100G, 6msec, XX'YY'ZZ', 10times each	and no visible damage		



ESD (HBM)	Human body model, 1.5 Kohm, 100 pF, 0.4KV	$\Delta$ R/R max. $\pm$ (1%+0.05 $\Omega$ )	< 50mΩ
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#### **PACKAGING**

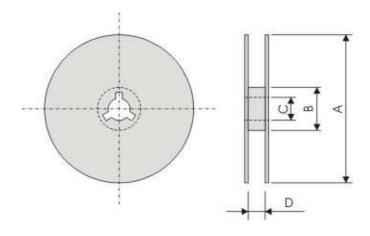
#### Paper Tape specifications (unit :mm)



Series No.	А	В	W	F	E
MR02X	0.67±0.05	0.37±0.05	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD	T
MR02X	2.00±0.05	4.00±0.05	Ф1.50 <sup>+0.1</sup>	0.45±0.05

#### **Reel dimensions**



Symbol	Α	В	С	D
7" Reel	Φ178.0±0.2	Φ60.0±1.0	13.0±0.2	9.0±0.5
13" Reel	Ф330.0±2.0	Φ100.0±1.0	13.0±0.2	9.0±0.5

#### **Taping quantity and Tape material**

- Chip resistors 15,000 pcs 7" Reel, Paper tape.
- Chip resistors 70,000 pcs 13" Reel, Paper tape.